

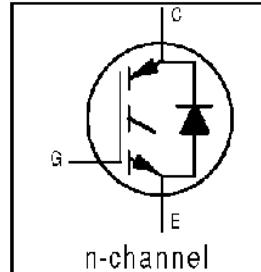
# IRG4PH40KDPbF

## INSULATED GATE BIPOLAR TRANSISTOR WITH ULTRAFAST SOFT RECOVERY DIODE

Short Circuit Rated  
UltraFast IGBT

### Features

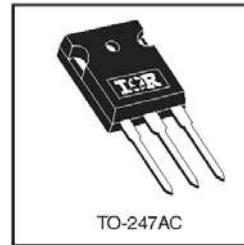
- High short circuit rating optimized for motor control,  $t_{sc} = 10\mu s$ ,  $V_{CC} = 720V$ ,  $T_J = 125^\circ C$ ,  $V_{GE} = 15V$
- Combines low conduction losses with high switching speed
- Tighter parameter distribution and higher efficiency than previous generations
- IGBT co-packaged with HEXFRED™ ultrafast ultrasoft recovery antiparallel diodes
- Lead-Free



$V_{CES} = 1200V$   
 $V_{CE(on)} \text{ typ.} = 2.74V$   
 $\text{@ } V_{GE} = 15V, I_C = 15A$

### Benefits

- Latest generation 4 IGBT's offer highest power density motor controls possible
- HEXFRED™ diodes optimized for performance with IGBTs. Minimized recovery characteristics reduce noise, EMI and switching losses
- This part replaces the IRGPH40KD2 and IRGPH40MD2 products
- For hints see design tip 97003



### Absolute Maximum Ratings

	Parameter	Max.	Units
$V_{CEO}$	Collector-to-Emitter Voltage	1200	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	30	
$I_C @ T_C = 100^\circ C$	Continuous Collector Current	15	
$I_{C(peak)}$	Pulsed Collector Current (1)	60	
$I_{LM}$	Clamped Inductive Load Current (2)	60	
$I_F @ T_C = 100^\circ C$	Diode Continuous Forward Current	8.0	
$I_{FV}$	Diode Maximum Forward Current	130	
$t_{sc}$	Short Circuit Withstand Time	10	$\mu s$
$V_{GE}$	Gate-to-Emitter Voltage	$\pm 20$	V
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	160	
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	65	
$T_J$	Operating Junction and	-55 to +150	
$T_{Storage}$	Storage Temperature Range		$^\circ C$
	Soldering Temperature, for 10 sec.	300 (0.063 in. (1.6mm) from case)	
	Mounting Torque, 6-32 or M3 Screw	10 lbf-in (1.1 N·m)	

### Thermal Resistance

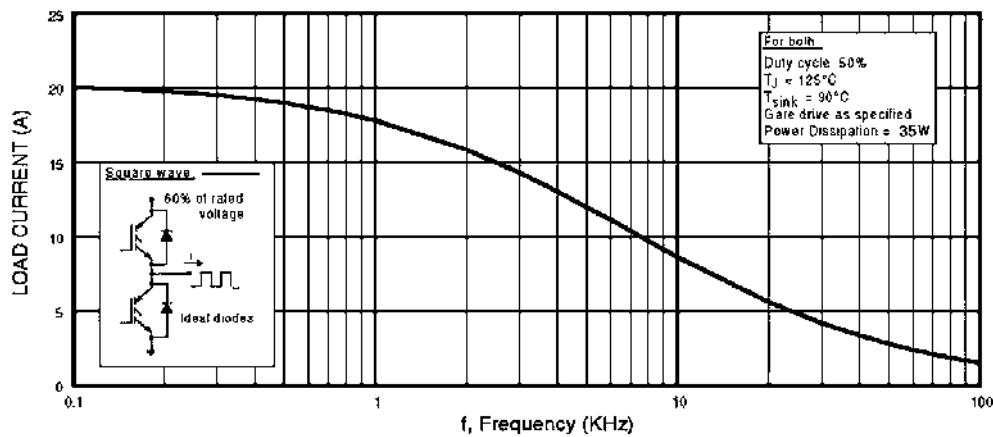
	Parameter	Min.	Typ.	Max.	Units
$R_{J-C}$	Junction-to-Case - IGBT	—	—	0.77	$^\circ C/W$
$R_{D-C}$	Junction-to-Case - Diode	—	—	1.7	
$R_{C-S}$	Case-to-Sink, flat, greased surface	—	0.24	—	
$R_{J-A}$	Junction-to-Ambient, typical socket mount	—	—	40	
Wt	Weight	—	6 (0.21)	—	g (oz)

**Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

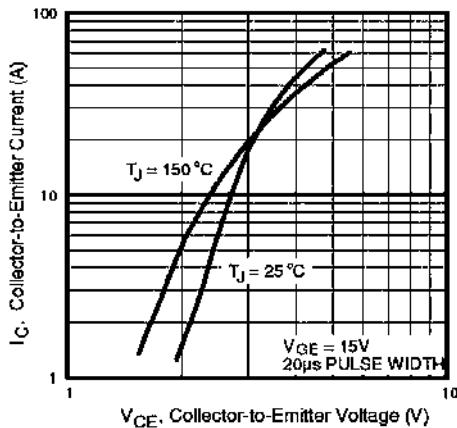
Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{BE(BD)}$	Collector-to-Emitter Breakdown Voltage	1200	—	—	V $V_{GE} = 0\text{V}$ , $I_C = 250\mu\text{A}$
$\Delta V_{BE(BD)/\Delta T_J}$	Temperature Coeff. of Breakdown Voltage	—	0.37	—	$\text{V}/^\circ\text{C}$ $V_{GF} = 0\text{V}$ , $I_C = 1.0\text{mA}$
$V_{CE(on)}$	Collector-to-Emitter Saturation Voltage	—	2.74	3.4	$I_C = 15\text{A}$ $V_{GE} = 15\text{V}$
		—	3.29	—	$V$ $I_C = 30\text{A}$ See Fig. 2, 5
		—	2.53	—	$I_C = 15\text{A}$ , $T_J = 150^\circ\text{C}$
$V_{G(th)}$	Gate Threshold Voltage	3.0	—	6.0	$V_{GE} = V_{GE}$ , $I_C = 250\mu\text{A}$
$\Delta V_{G(th)/\Delta T_J}$	Temperature Coeff. of Threshold Voltage	—	-3.3	—	$\text{mV}/^\circ\text{C}$ $V_{GE} = V_{GE}$ , $I_C = 250\mu\text{A}$
$g_{FE}$	Forward Transconductance	8.0	12	—	S $V_{GE} = 100\text{V}$ , $I_C = 15\text{A}$
$I_{CES}$	Zero Gate Voltage Collector Current	—	—	250	$\mu\text{A}$ $V_{GE} = 0\text{V}$ , $V_{OF} = 1200\text{V}$
		—	—	3000	$V_{GF} = 0\text{V}$ , $V_{OF} = 1200\text{V}$ , $T_J = 150^\circ\text{C}$
$V_{FV}$	Diode Forward Voltage Drop	—	2.6	3.3	V $I_C = 8.0\text{A}$ See Fig. 13
		—	2.4	3.1	$I_C = 8.0\text{A}$ , $T_J = 125^\circ\text{C}$
$I_{GES}$	Gate-to-Emitter Leakage Current	—	—	$\pm 100$	nA $V_{GE} = \pm 20\text{V}$

**Switching Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

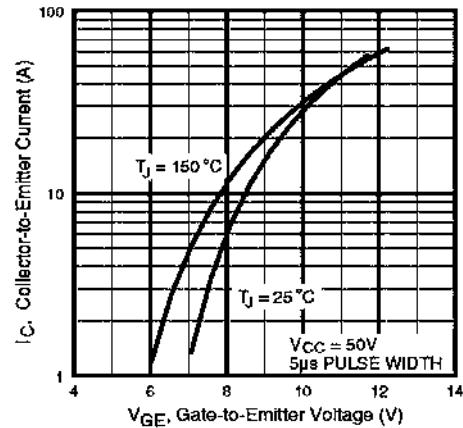
Parameter	Min.	Typ.	Max.	Units	Conditions
$Q_g$	Total Gate Charge (turn-on)	—	94	140	$I_C = 15\text{A}$ $V_{CC} = 400\text{V}$ See Fig. 8 $V_{GE} = 15\text{V}$
$Q_{ge}$	Gate - Emitter Charge (turn-on)	—	14	22	
$Q_{go}$	Gate - Collector Charge (turn-on)	—	37	55	
$t_{d(on)}$	Turn-On Delay Time	—	50	—	$T_J = 25^\circ\text{C}$ $I_C = 15\text{A}$ , $V_{CC} = 800\text{V}$ $V_{GE} = 15\text{V}$ , $R_G = 10\Omega$ Energy losses include "tail" and diode reverse recovery See Fig. 9, 10, 18
$t_r$	Rise Time	—	31	—	
$t_{d(off)}$	Turn-Off Delay Time	—	96	140	
$t_f$	Fall Time	—	220	330	
$E_{on}$	Turn-On Switching Loss	—	1.31	—	
$E_{off}$	Turn-Off Switching Loss	—	1.12	—	
$E_{ts}$	Total Switching Loss	—	2.43	2.8	
$t_{sc}$	Short Circuit Withstand Time	10	—	μs	
$t_{d(on)}$	Turn-On Delay Time	—	49	—	$V_{CC} = 720\text{V}$ , $T_J = 125^\circ\text{C}$ $V_{GE} = 15\text{V}$ , $R_G = 10\Omega$ , $V_{CPK} < 500\text{V}$ $T_J = 150^\circ\text{C}$ , See Fig. 10, 11, 18
	Rise Time	—	33	—	
	Turn-Off Delay Time	—	290	—	
$t_f$	Fall Time	—	440	—	
$E_{ts}$	Total Switching Loss	—	5.1	—	
$L_E$	Internal Emitter Inductance	—	13	—	
$C_{ies}$	Input Capacitance	—	1600	—	
$C_{ooc}$	Output Capacitance	—	77	—	
$C_{res}$	Reverse Transfer Capacitance	—	26	—	
$t_{rr}$	Diode Reverse Recovery Time	—	63	95	$T_J = 25^\circ\text{C}$ See Fig. $T_J = 125^\circ\text{C}$ 14 $I_F = 8.0\text{A}$ $T_J = 25^\circ\text{C}$ See Fig. $T_J = 125^\circ\text{C}$ 15 $V_R = 200\text{V}$ $T_J = 25^\circ\text{C}$ See Fig. $T_J = 125^\circ\text{C}$ 16 $dI/dt = 200\text{A}/\mu\text{s}$ $T_J = 25^\circ\text{C}$ See Fig. $T_J = 125^\circ\text{C}$ 17
	Diode Peak Reverse Recovery Current	—	106	160	
$Q_{rr}$	Diode Reverse Recovery Charge	—	4.5	8.0	
	Diode Reverse Recovery Charge	—	6.2	11	
$di_{recM}/dt$	Diode Peak Rate of Fall of Recovery During $t_f$	—	140	380	
	Diode Peak Rate of Fall of Recovery During $t_f$	—	335	880	
	Diode Peak Rate of Fall of Recovery During $t_f$	—	133	—	
	Diode Peak Rate of Fall of Recovery During $t_f$	—	85	—	



**Fig. 1 - Typical Load Current vs. Frequency**  
 (Load Current =  $I_{RMS}$  of fundamental)



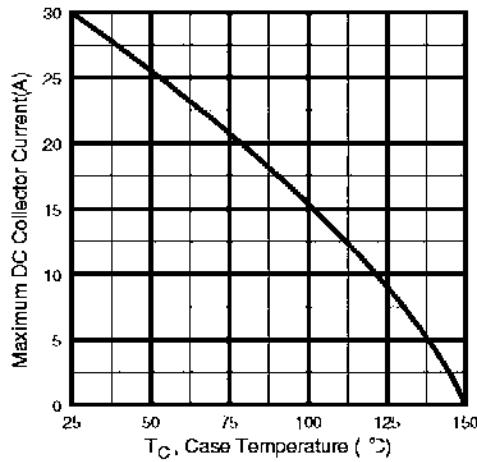
**Fig. 2 - Typical Output Characteristics**



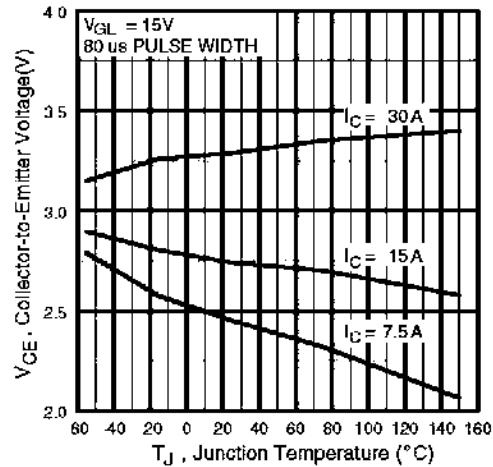
**Fig. 3 - Typical Transfer Characteristics**

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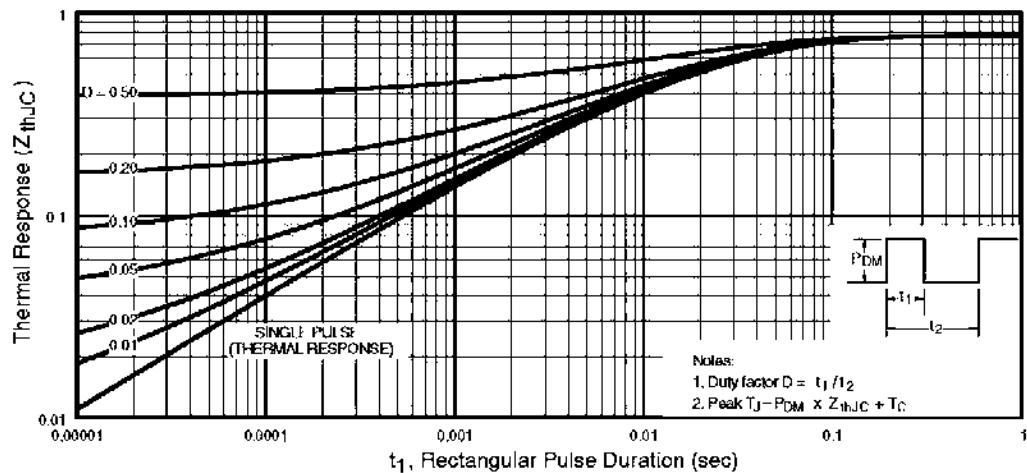
International  
**IR** Rectifier



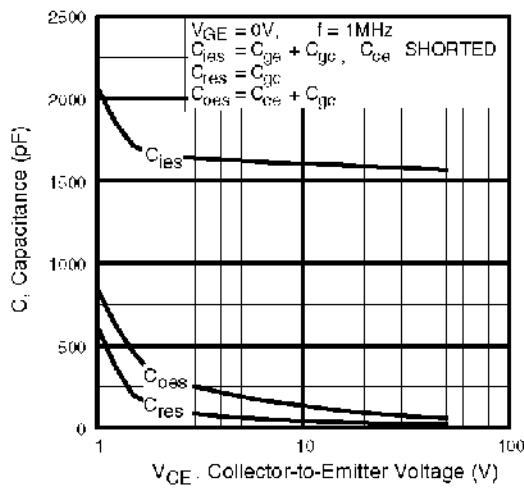
**Fig. 4** - Maximum Collector Current vs. Case Temperature



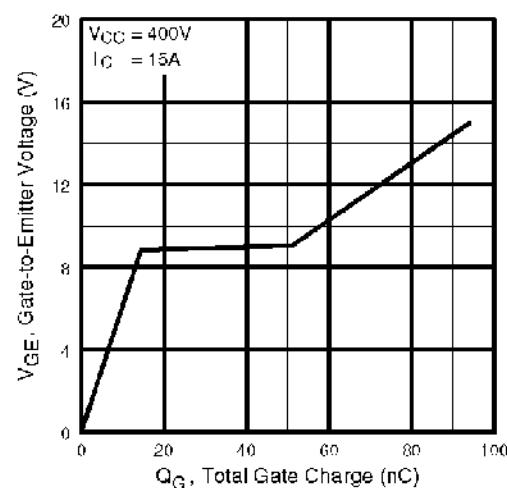
**Fig. 5** - Typical Collector-to-Emitter Voltage vs. Junction Temperature



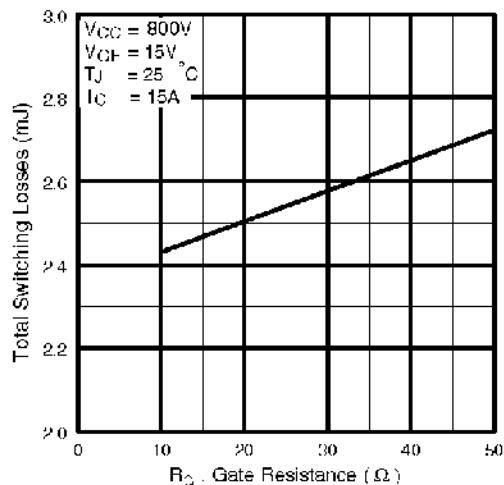
**Fig. 6** - Maximum Effective Transient Thermal Impedance, Junction-to-Case



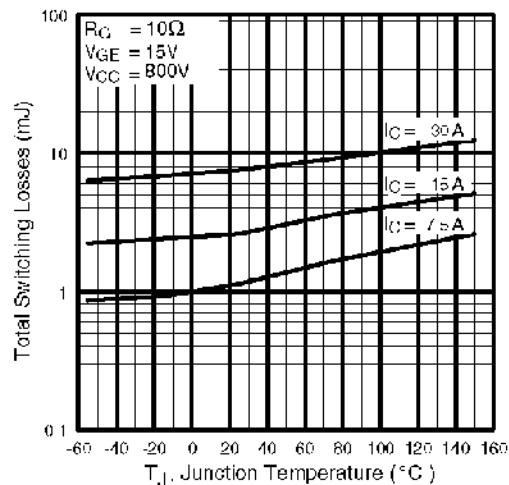
**Fig. 7** - Typical Capacitance vs.  
Collector-to-Emitter Voltage



**Fig. 8** - Typical Gate Charge vs.  
Gate-to-Emitter Voltage



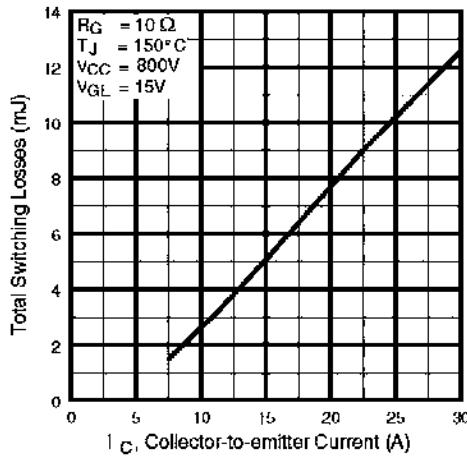
**Fig. 9** - Typical Switching Losses vs. Gate  
Resistance



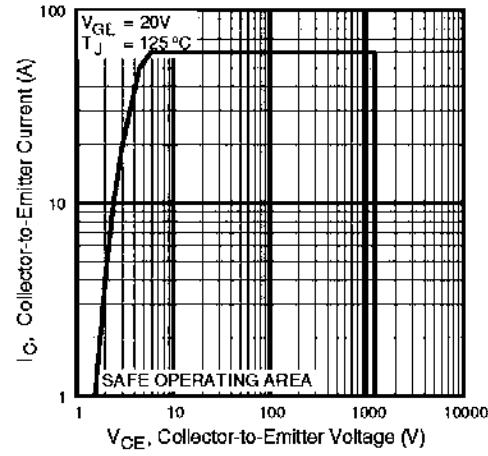
**Fig. 10** - Typical Switching Losses vs.  
Junction Temperature

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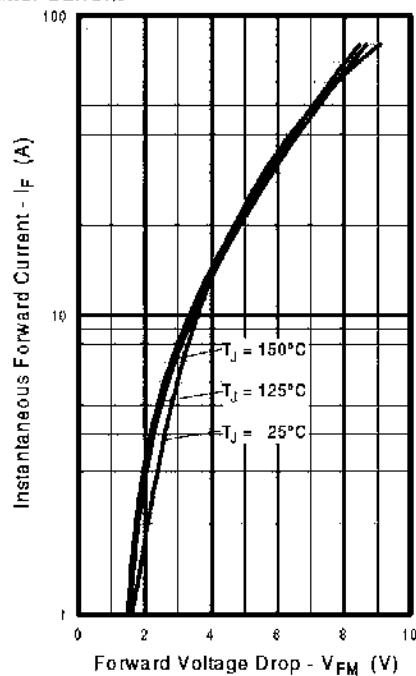
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**IR** Rectifier



**Fig. 11** - Typical Switching Losses vs.  
Collector-to-Emitter Current



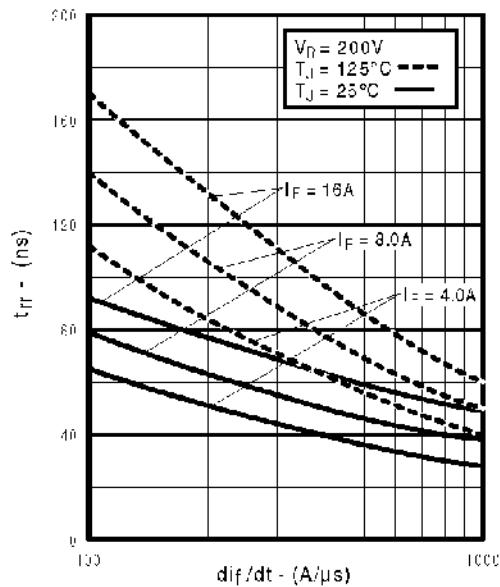
**Fig. 12** - Turn-Off SOA



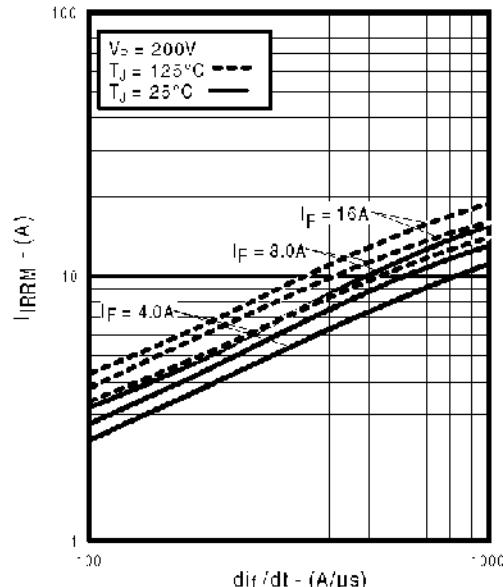
**Fig. 13** - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

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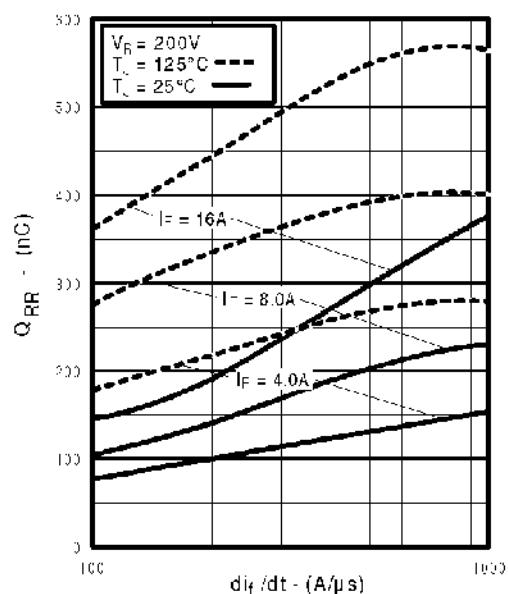
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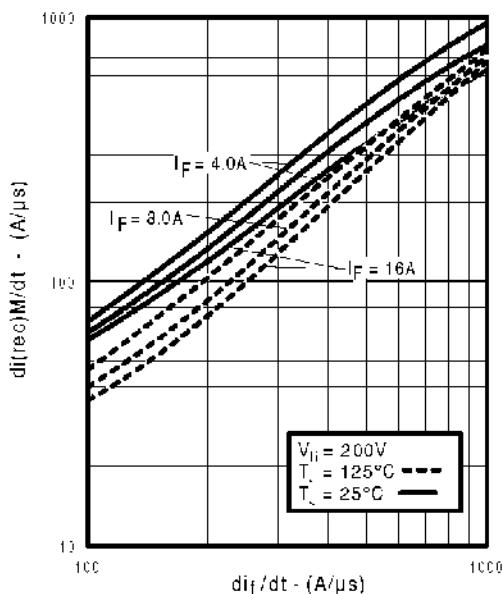
**Fig. 14** - Typical Reverse Recovery vs.  $di/dt$



**Fig. 15** - Typical Recovery Current vs.  $di/dt$



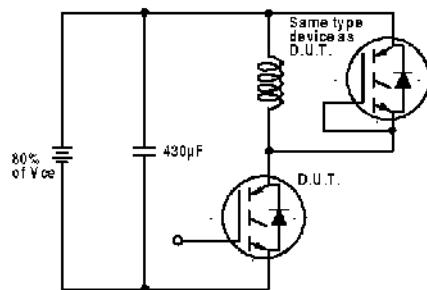
**Fig. 16** - Typical Stored Charge vs.  $di/dt$



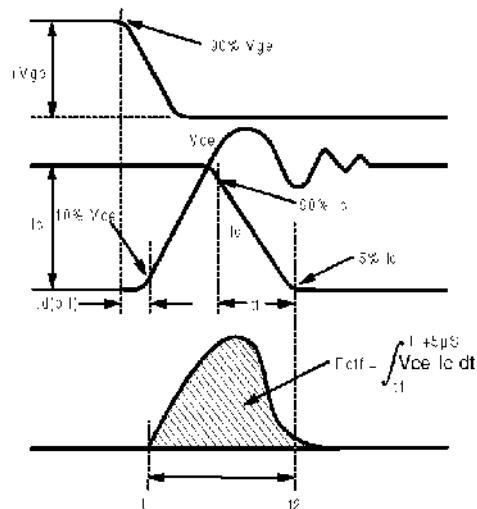
**Fig. 17** - Typical  $d[reco]M/dt$  vs.  $di/dt$

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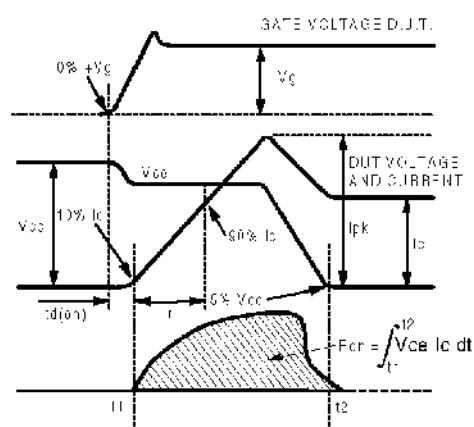
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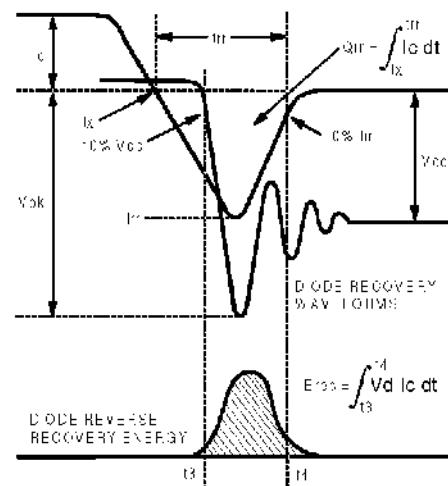
**Fig. 18a** - Test Circuit for Measurement of  $I_{LM}$ ,  $E_{on}$ ,  $E_{off(diode)}$ ,  $t_m$ ,  $Q_m$ ,  $I_m$ ,  $t_d(on)$ ,  $t_f$ ,  $t_d(off)$ ,  $t_r$



**Fig. 18b** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{off}$ ,  $t_d(off)$ ,  $t_f$



**Fig. 18c** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{off}$ ,  $t_d(on)$ ,  $t_f$



**Fig. 18d** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{rec}$ ,  $t_m$ ,  $Q_m$ ,  $I_m$

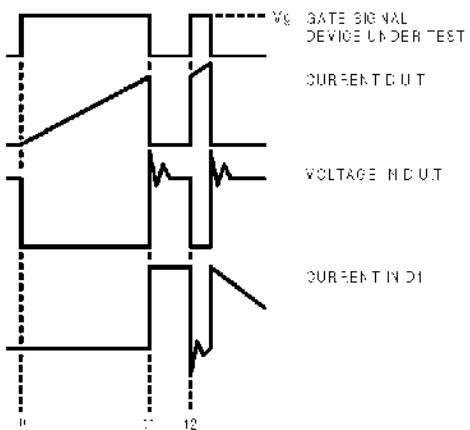


Figure 18e. Macro Waveforms for Figure 18a's Test Circuit

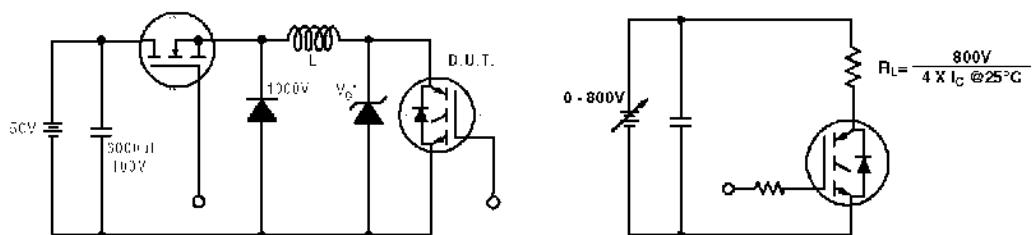


Figure 19. Clamped Inductive Load Test Circuit

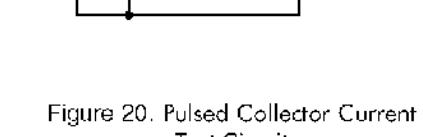


Figure 20. Pulsed Collector Current Test Circuit

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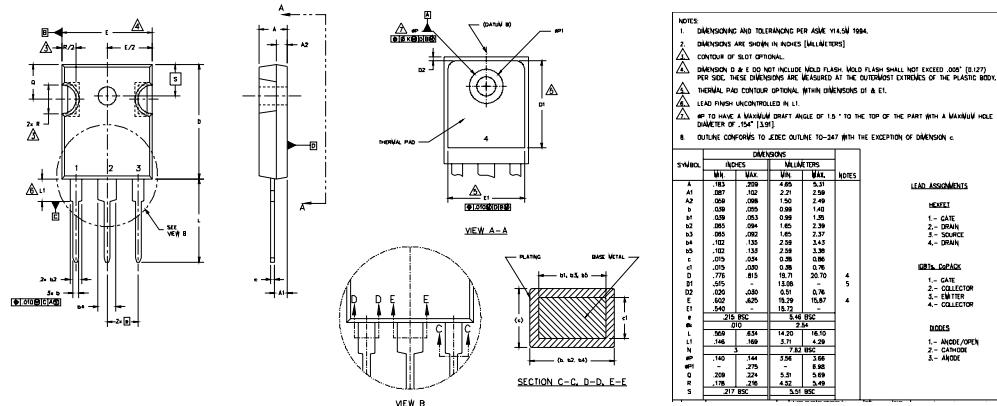
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## Notes:

- ① Repetitive rating:  $V_{GE}=20V$ ; pulse width limited by maximum junction temperature (figure 20)
- ②  $V_{CC}=80\% (V_{GS})$ ,  $V_{GR}=20V$ ,  $L=10\mu H$ ,  $R_C=10\Omega$  (figure 19)
- ③ Pulse width  $\leq 80\mu s$ ; duty factor  $\leq 0.1\%$ .
- ④ Pulse width  $5.0\mu s$ , single shot.

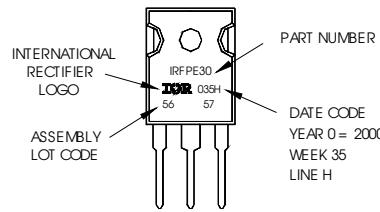
## TO-247AC Package Outline

Dimensions are shown in millimeters (inches)



## TO-247AC Part Marking Information

EXAMPLE: THIS IS AN IRFPE30  
WITH ASSEMBLY  
LOT CODE 5657  
ASSEMBLED ON WW.35, 2000  
IN THE ASSEMBLY LINE "H"  
Note: "P" in assembly line  
position indicates "Lead-Free"



Data and specifications subject to change without notice.

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Note: For the most current drawings please refer to the IR website at:  
<http://www.irf.com/package/>